9. Signature:

07 - 16 - 2009

Fon		U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office			
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1 100.00	67480	ENTS	ONLY	•	
To the Director of the U.S.	Patent and Trademark Off	ice: Please r	record the attach	ned documents or the new a	ddress(es) below.
Name of conveying party(ies):			2. Name and address of receiving party(ies)		
Osamu KOIKE (07/02/2009) and Yutaka KADOGAWA (07/02/2009)			Name: OKI SEMICONDUCTOR CO., LTD.		
Additional name(s) of conveying		x No	Internal Address Street Address		
3. Nature of conveyance/Execution Date(s): Execution Date(s): in parentheses after inventor name X Assignment Merger Change of Name			550-1 Higashiasakawa-cho Hachiouji-shi		
Security Agreement Joint Research Agreement			City: Tokyo		
Government Interest Assignment			State:		
Executive Order 9424, Confirmatory License Other			Country: JAPAN Zip: 193-8550 Additional name(s) & address(es) Yes X No attached?		
Application or patent A. Patent Application No.(This application	s)	×Τ	his document is B. Patent I	being filed together with a r No.(s)	new application.
	Additional number	s attached?	Yes	χNο	
5. Name and address to whom correspondence concerning document should be mailed;		6. Total number patents invo	er of applications and plved:	1 .	
Name: Robert H. Berdo, Jr. RABIN & BERDO, PC		7. Total fee (37	7 CFR 1.21(h) & 3.41) \$_	40.00	
Internal Address: Atty. Dkt.: FUJI-222 Street Address: 1101 14th St., NW Suite 500			Authorized to be charged to deposit account Enclosed None required (government interest not affecting title)		
City:	Washington		8. Payment Inf	ormation	·
State: DC	 ' 	0005			
Phone Number:	(202) 371-8976				
Fax Number: (202) 408-0924			Deposit Account Number Authorized User Name		
Email Address:	firm@rabinberdo.cor	Π	Authorized	Oser Name	

U.S. PTO 12/458324 07/08/2009

Signature

Robert H. Berdo, Jr. - 38,075

Name of Person Signing

July 8, 2009

Date

Total number of pages including cover sheet, attachments, and documents:

07/09/2009 SMDHAMME 00000069 12458324

04 FC:8021

49.09 OP

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PATENT REEL: 022970 FRAME: 0089

ASSIGNMENT OF APPLIC	ATION FOR UNITED STATES LETTERS PATENT
WHEREAS Osamu KOIKE a	and Yutaka KADOGAWA
pereinafter referred to collectively as the as	ssignor, has invented a certain improvement METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE,
METHOD FOR MANUFACTURI	NG SEMICONDUCTOR PACKAGE
 the inventor(s) declaration for said anstrument, said application to be filed in th 	application being executed concurrently with the execution of this e United States Patent and Trademark Office; e United States Patent and Trademark Office on,
	being hereby given to the practitioners associated with the
<u>Customer Number 23995,</u> to No) the ap	insert here in parentheses (Application Serial oplication serial number of said application when known;
] said application having been filed unde Serial No.)	r the Patent Cooperation Treaty on, the United States of America being designated.
AND WHEREAS OKI SEMICONDUC	
hardinaffor referred to se the acciones i	sakawa-cho Hachiouji-shi, Tokyo 193-8550, Japan s desirous of acquiring the entire right, title and interest in and to
aid application, including any and all divi	sions and continuations thereof, and in and to said invention and anted therefor, including any and all renewals, reissues and
NOW THIS WITNESSETH, that for	and in consideration of One Dollar (\$1.00), and other good and see to said assignor, the receipt of which is hereby acknowledged,
aid assignor hereby assigns, sells and issigns, the full and exclusive right, title ar	transfers to said assignee, and said assignee's successors and interest in and to said application, including any and all divisions
ncluding any and all renewals, reissues	id invention and any and all patents which may be granted therefor, and prolongations thereof; said assignee, and said assignee's
and continuations thereof, and the said in	ercise and enjoy the said application, including any and all divisions evention and any and all patents which may be granted therefor,
advantages in anywise arising from or apposed patents when granted, including any and benefit of said assignee, and said a	nd prolongations thereof, with all the rights, powers, privileges and pertaining thereto, for and during the term or terms of any and all and all renewals, reissues and prolongations thereof, for the use ssignee's successors and assigns, in as ample and beneficial a dhave held and enjoyed the same, if this assignment had not been
nade.	to perform, upon the request of said assignee, or said assignee's
successors or assigns, any and all acts re any and all renewals, reissues and prolong	lating to the obtaining or to the asserting of said patents, including ations thereof.
etters Patent on said application, and on a	requests the Commissioner of Patents and Trademarks to issue any and all divisions and continuations thereof, essors and assigns, in accordance herewith.
AND Assignors hereby grant the	following individuals the power to insert on this Assignment any sary or desirable in order to comply with the rules of the United
All practitioners at Customer Number 2399 AND Assignors acknowledge an o nvention was made.	95. bligation of assignment of this invention to Assignee at the time the
EXECUTED, July	1 2 , 2009
WITNESS:	ASSIGNOR:
Signature: <u>Laisuka Unoma</u>	ta Signature: Osamu Korke Name: Osamu KOIKE
	Coamu Noine

Rabin & Berdo, PC
Page 1 of 2

Attorney Reference

	EXECUTED, July	2. 2004	*
TTNESS:		ASSIGNOR:	
Signature:	Shinichtra Kashinagi	Signature:	Jutaka Kadogawa
		Name:	Yutaka KADOGAWA

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Page 2 of 2

RECORDED: 07/08/2009